



CALL FOR PAPERS

ICTMPV 2022
Apr 29-30, 2022
Jerusalem, Israel

The International Research Conference is a federated organization dedicated to bringing together a significant number of diverse scholarly events for presentation within the conference program. Events will run over a span of time during the conference depending on the number and length of the presentations.

ICTMPV 2022 : International Conference on Transfer Molding, Processes and Variations is the premier interdisciplinary forum for the presentation of new advances and research results in the fields of Transfer Molding, Processes and Variations. The conference will bring together leading academic scientists, researchers and scholars in the domain of interest from around the world. Topics of interest for submission include, but are not limited to:

Transfer molding
Transfer molding techniques
Processes and variations
Resin transfer molding

Vacuum assisted resin transfer
molding
Micro transfer molding
Transfer molding and compression
molding